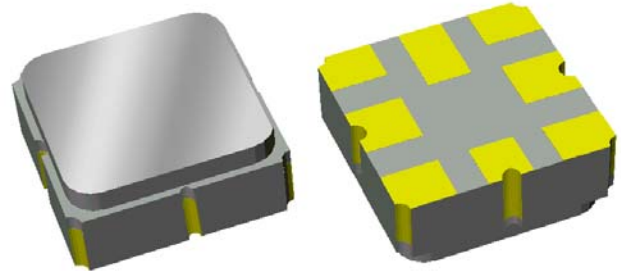


Preliminary Data Sheet

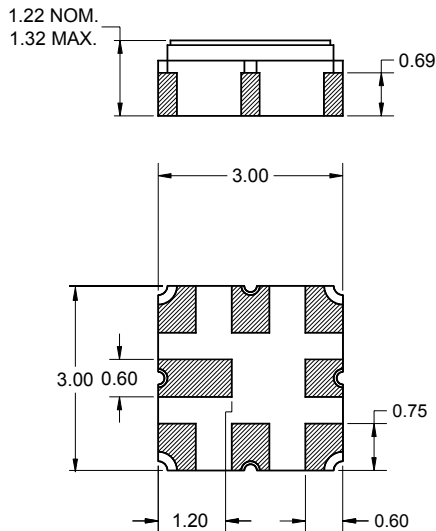
Features

- For broadband access applications
- Usable bandwidth 10 MHz
- Low loss
- High attenuation
- No impedance matching required for operation at 200 Ω
- Balanced operation
- Ceramic Surface Mount Package (SMP)
- Small size



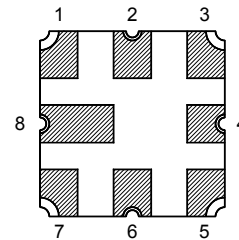
Package

Surface Mount 3.00 x 3.00 x 1.22 mm



Pin Configuration

Bottom View



Pin No.	Description
1	Input
2	Input return
5	Output return
6	Output
3,4,7,8	Case Ground

Dimensions shown are nominal in millimeters
 All tolerances are ± 0.15 mm except overall
 length and width ± 0.10 mm

Body: Al_2O_3 ceramic
 Lid: Kovar, Ni plated
 Terminations: Au plating 0.5 - 1.0 μ m,
 over a 2 - 6 μ m Ni plating

Preliminary Data Sheet

Electrical Specifications ⁽¹⁾

Operating Temperature Range: ⁽²⁾ -10 to +70 °C

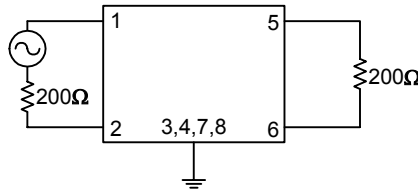
Parameter ⁽³⁾	Minimum	Typical	Maximum	Unit
Center Frequency	-	1220	-	MHz
Maximum Insertion Loss 1215 - 1225 MHz	-	4.5	5.5	dB
Lower 1.5 dB Bandedge ⁽⁴⁾ Upper 1.5 dB Bandedge	- 1225	1209.5 1230.5	1215 -	MHz MHz
Stopband Rejection ⁽⁴⁾ 500 - 1152 MHz	55	60	-	dB
1152 - 1190 MHz	30	55	-	dB
1250 - 1288 MHz	30	55	-	dB
1288 - 2000 MHz	55	50	-	dB
Amplitude Ripple ⁽⁵⁾ 1215 - 1225 MHz	-	0.5	1.5	dB
Group Delay Ripple ⁽⁵⁾ 1215 - 1225 MHz	-	30	-	ns
Source Impedance ⁽⁶⁾	-	200	-	Ω
Load Impedance ⁽⁶⁾	-	200	-	Ω

Notes:

- All specifications are based on the test circuit shown below
- In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
- Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
- All attenuation measurements will be referenced the insertion loss at center frequency
- Maximum peak to adjacent valley measured over the defined range
- This is the optimum impedance in order to achieve the performance shown

Test Circuit:

200 Ω
Balanced

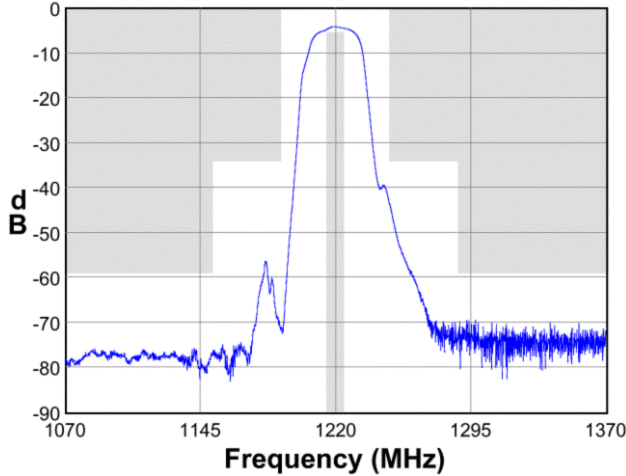


No impedance matching
required

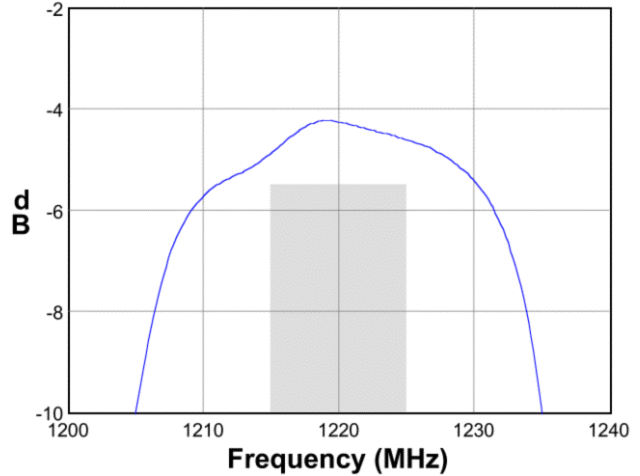
Preliminary Data Sheet

Typical Performance (at +25°C)

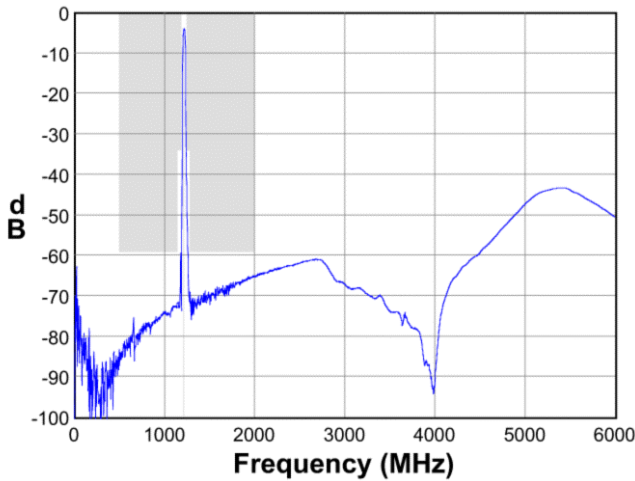
Frequency Response



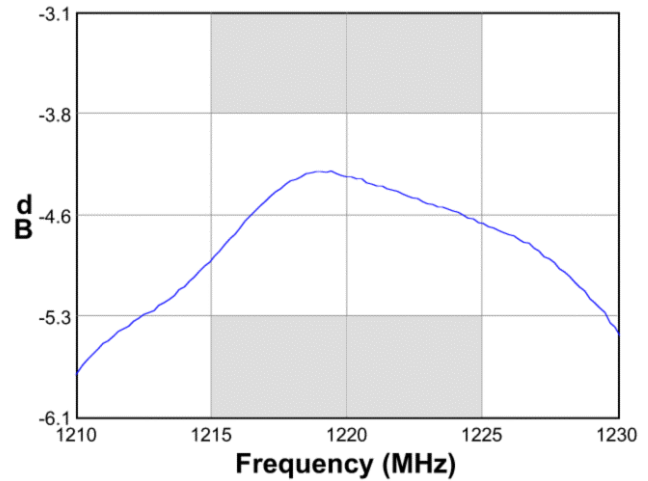
Passband Response



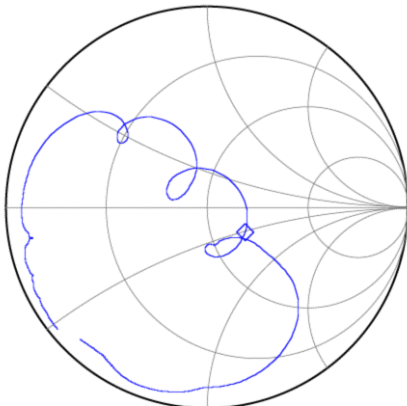
Wideband Response



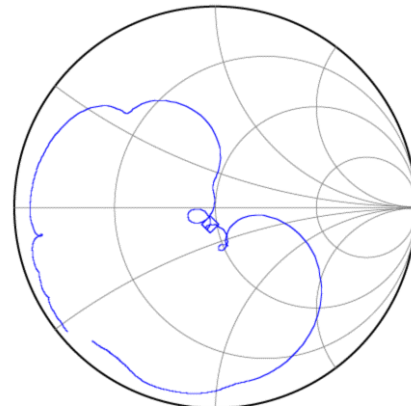
Amplitude Ripple



Input Smith Chart



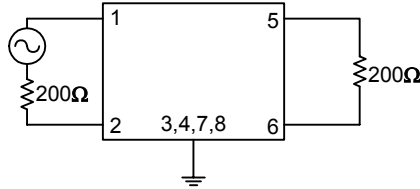
Output Smith Chart



Preliminary Data Sheet

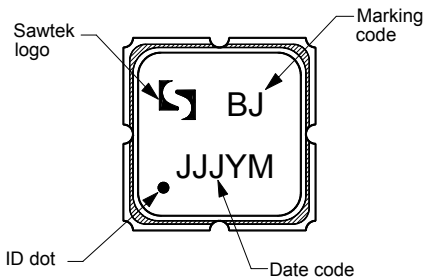
Matching Schematics

200 Ω
Balanced



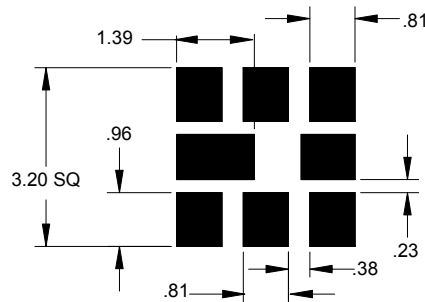
No impedance matching
required

Marking



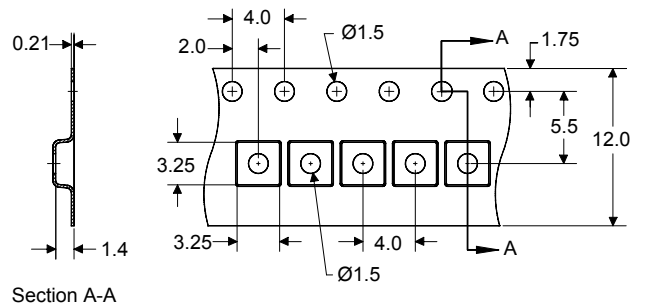
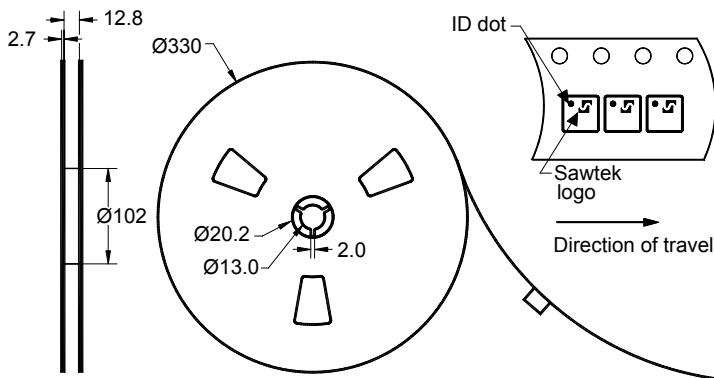
The date code consists of: JJJ = Julian day,
Y = last digit of year, M = manufacturing site code

PCB Footprint



This footprint represents a recommendation only
Dimensions shown are nominal in millimeters

Tape and Reel



Dimensions shown are nominal in millimeters
Packaging quantity: 5000 units/reel

Preliminary Data Sheet

Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	-10	+70	°C
Storage Temperature Range	T _{stg}	-40	+85	°C

Warnings

- Electrostatic Sensitive Device (ESD)
- Avoid ultrasonic exposure



Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[Other Technical Information](#)

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